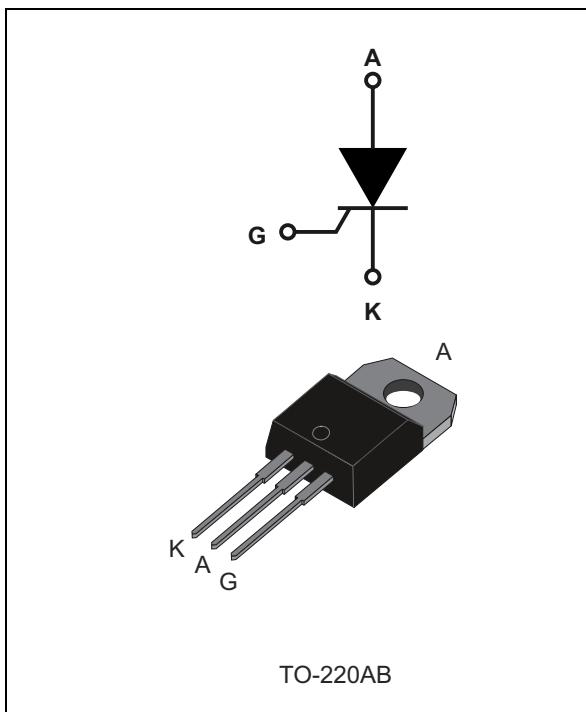


## High temperature 16 A SCRs

Datasheet – production data



### Description

Thanks to a junction temperature  $T_j$  up to 150 °C and a non-isolated TO-220 package, the TN1610H-6T offers high thermal performance operation up to 16 A rms.

The trade-off between the device's noise immunity ( $dV/dt = 1 \text{ kV}/\mu\text{s}$ ), its gate triggering current ( $I_{GT} = 10 \text{ mA}$ ) and its turn-on current rise ( $di/dt = 100 \text{ A}/\mu\text{s}$ ) allows the design of robust and compact control circuits for voltage regulators in motorbikes and industrial drives, overvoltage crowbar protection, motor control circuits in power tools and kitchen appliances and inrush current limiting circuits.

**Table 1. Device summary**

Order code	Package	$V_{DRM}/V_{RRM}$	$I_{GT}$
TN1610H-6T	TO-220AB	600 V	10 mA

### Features

- High junction temperature:  $T_j = 150 \text{ }^\circ\text{C}$
- High noise immunity  $dV/dt = 1000 \text{ V}/\mu\text{s}$  up to 150 °C
- Gate triggering current  $I_{GT} = 10 \text{ mA}$
- Blocking voltage  $V_{DRM}/V_{RRM} = 600 \text{ V}$
- High turn on current rise  $di/dt$ : 100 A/ $\mu\text{s}$
- ECOPACK®2 compliant component

### Applications

- Voltage regulator circuits for motorbikes
- Inrush current limiting circuits
- Motor control circuits and starters
- Light dimmers
- Solid state relays

# 1 Characteristics

Table 2. Absolute ratings

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	On-state rms current (180° conduction angle)	$T_c = 133 \text{ }^\circ\text{C}$	16	A	
$I_{T(AV)}$	Average on-state current (180° conduction angle)	$T_c = 133 \text{ }^\circ\text{C}$	10	A	
		$T_c = 138 \text{ }^\circ\text{C}$	8		
		$T_c = 142 \text{ }^\circ\text{C}$	6		
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = 25 °C)	$t = 8.3 \text{ ms}$	153	A	
		$t = 10 \text{ ms}$	140		
$I^2t$	$I^2t$ value for fusing ( $T_j$ initial = 25 °C)	$t_p = 10 \text{ ms}$	98	$\text{A}^2\text{s}$	
$dI/dt$	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \leq 100 \text{ ns}$ , $T_j = 25 \text{ }^\circ\text{C}$	$F = 60 \text{ Hz}$	100	$\text{A}/\mu\text{s}$	
$V_{DRM}$ , $V_{RRM}$	Repetitive peak off-state voltage		600	V	
$I_{GM}$	Peak gate current	$t_p = 20 \mu\text{s}$	$T_j = 150 \text{ }^\circ\text{C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 150 \text{ }^\circ\text{C}$	1	W
$T_{stg}$ $T_j$	Storage junction temperature range Operating junction temperature range		- 40 to + 150 - 40 to + 150	°C	
$T_L$	Maximum lead temperature for soldering during 10 s		260	°C	

Table 3. Electrical characteristics ( $T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified)

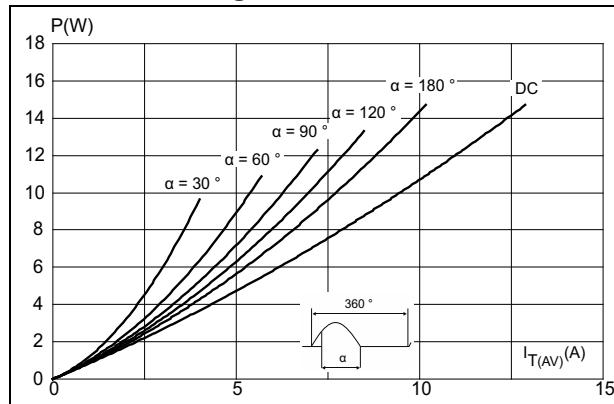
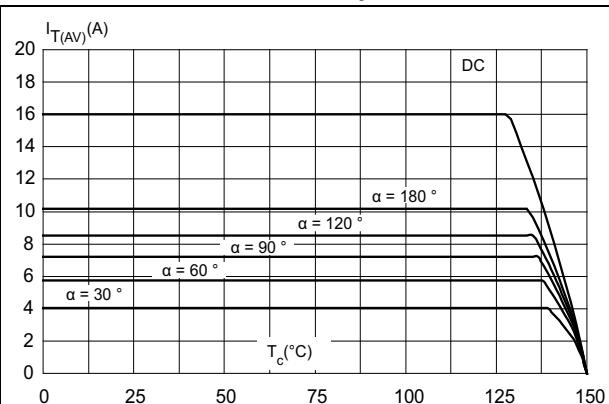
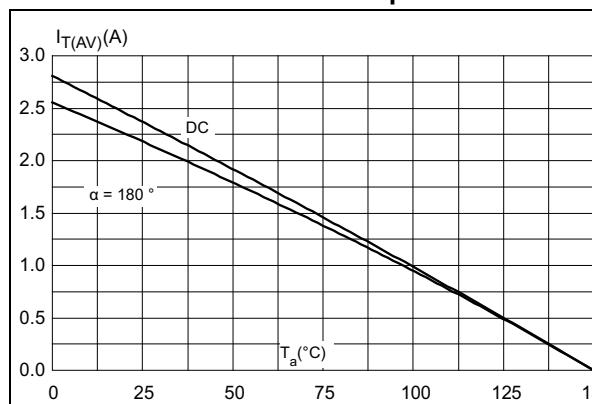
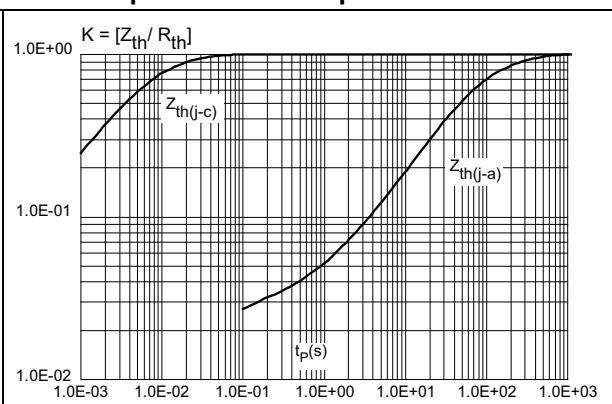
Symbol	Test conditions		Value	Unit
$I_{GT}$	$V_D = 12 \text{ V}$ , $R_L = 33 \Omega$	Typ.	4.5	mA
		Max.	10	
$V_{GT}$	$V_D = 12 \text{ V}$ , $R_L = 33 \Omega$		Max.	1.3
$V_{GD}$	$V_D = V_{DRM}$ , $R_L = 3.3 \text{ k}\Omega$	$T_j = 150 \text{ }^\circ\text{C}$	Min.	0.2
$I_H$	$I_T = 500 \text{ mA}$ , gate open		Max.	30
$I_L$	$I_G = 1.2 \times I_{GT}$		Max.	60
$dV/dt$	$V_D = 402 \text{ V}$ , gate open	$T_j = 150 \text{ }^\circ\text{C}$	Min.	1000
$t_{gt}$	$I_T = 32 \text{ A}$ , $V_D = 600 \text{ V}$ , $I_G = 100 \text{ mA}$ , ( $dI_G/dt$ )max = 0.2 A/ $\mu\text{s}$		Typ	1.9
$t_q$	$V_D = 402 \text{ V}$ , $V_R = 25 \text{ V}$ , $I_T = 16 \text{ A}$ , ( $dI_G/dt$ )max = 30 A/ $\mu\text{s}$ , $dV_D/dt = 40 \text{ V}/\mu\text{s}$	$T_j = 150 \text{ }^\circ\text{C}$	Typ	70

**Table 4. Static characteristics**

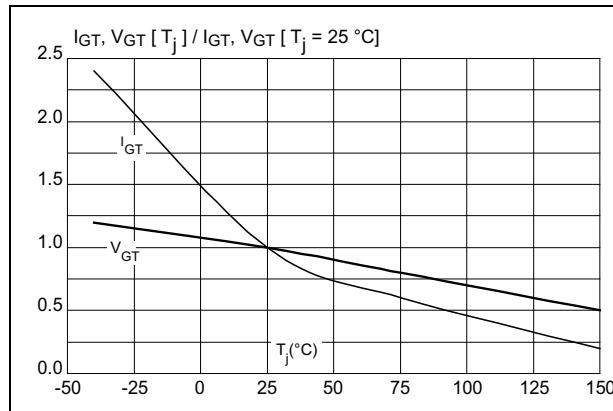
Symbol	Test conditions		Value	Unit
$V_{TM}$	$I_{TM} = 32 \text{ A}$ , $t_p = 380 \mu\text{s}$	$T_j = 25^\circ\text{C}$	Max.	1.6 V
$V_{t0}$	Threshold voltage	$T_j = 150^\circ\text{C}$	Max.	0.82 V
$R_d$	Dynamic resistance	$T_j = 150^\circ\text{C}$	Max.	25 mΩ
$I_{DRM}$ , $I_{RRM}$	$V_D = V_{DRM}$ , $V_R = V_{RRM}$	$T_j = 25^\circ\text{C}$	Max.	5 μA
		$T_j = 150^\circ\text{C}$	Max.	1.5 mA

**Table 5. Thermal resistance**

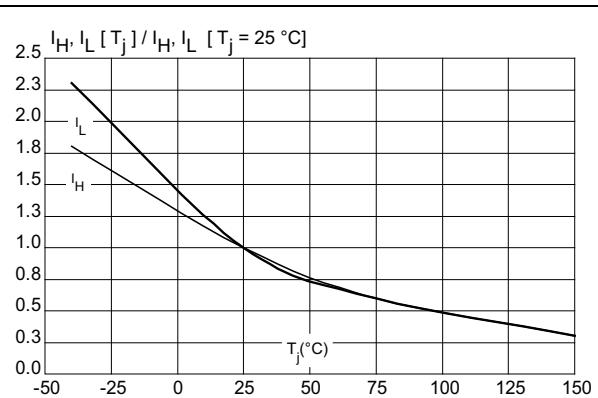
Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	1.1	°C/W
$R_{th(j-a)}$	Junction to ambient (DC)	60	°C/W

**Figure 1. Maximum power dissipation versus average on-state current****Figure 2. Average and DC on-state current versus case temperature****Figure 3. Average and DC on-state current versus ambient temperature****Figure 4. Relative variation of thermal impedance versus pulse duration**

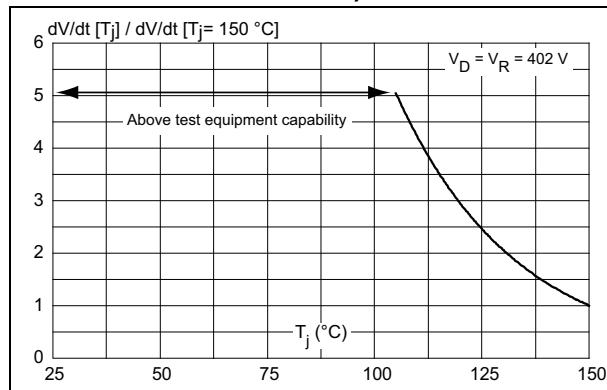
**Figure 5. Relative variation of gate triggering current and gate voltage versus junction temperature (typical values)**



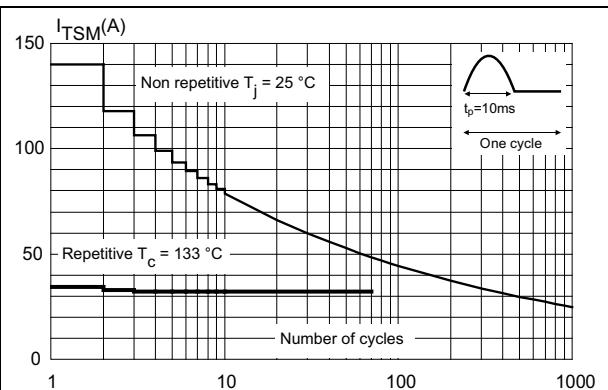
**Figure 6. Relative variation of holding current and latching current versus junction temperature (typical values)**



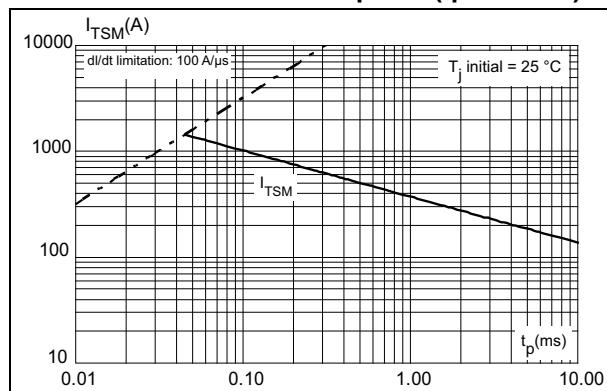
**Figure 7. Relative variation of static dV/dt immunity versus junction temperature (typical values)**



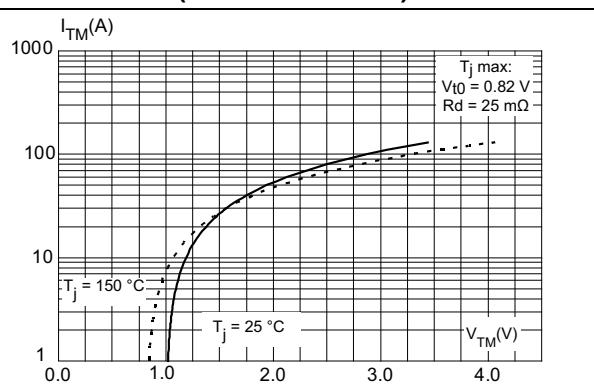
**Figure 8. Surge peak on-state current versus number of cycles**

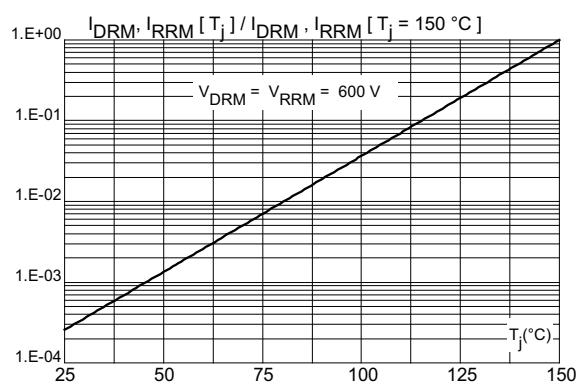


**Figure 9. Non-repetitive surge peak on-state current for a sinusoidal pulse ( $t_p < 10 \text{ ms}$ )**



**Figure 10. On-state characteristics (maximum values)**



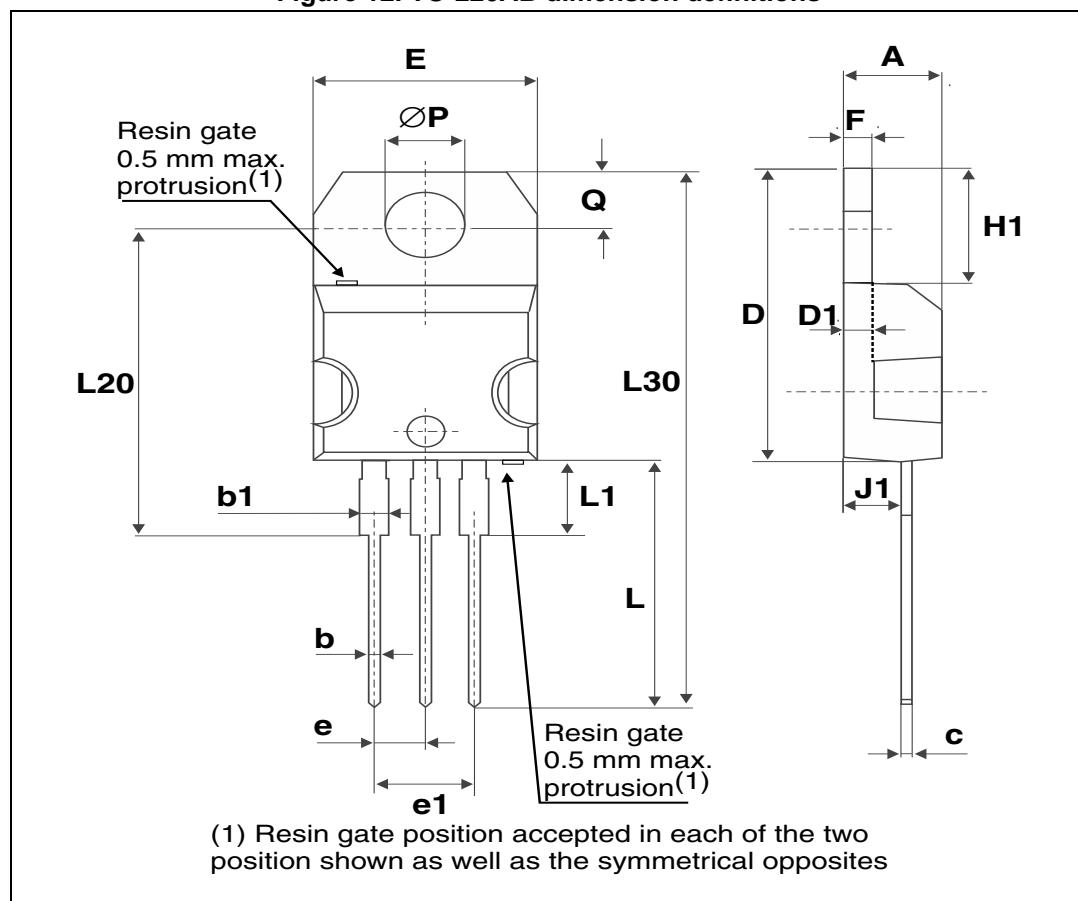
**Figure 11. Relative variation of leakage current versus junction temperature ( $t_p < 10$  ms)**

## 2 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Halogen free molding compound
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
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Figure 12. TO-220AB dimension definitions



**Table 6. TO-220AB dimension values**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	

### 3 Ordering information

Figure 13. Ordering information scheme

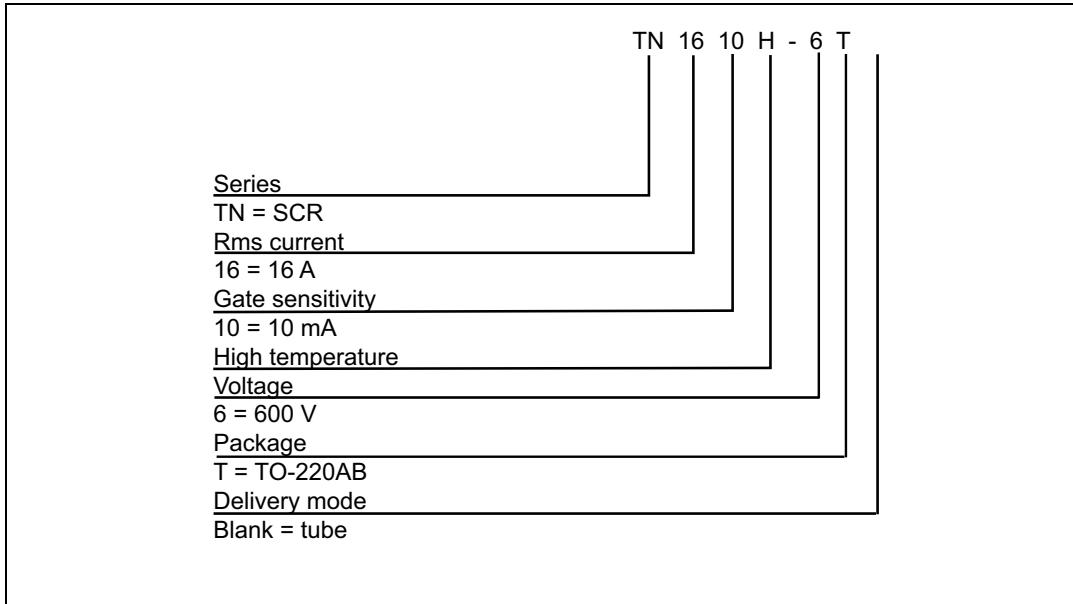


Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
TN1610H-6T	TN1610H6	TO-220AB	2.3 g	50	Tube

### 4 Revision history

Table 8. Document revision history

Date	Revision	Changes
24-Feb-2015	1	Initial release.

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